December 2013

FQP8N80C / FQPF8N80C / FQPF8N80CYDTU

N-Channel QFET® MOSFET

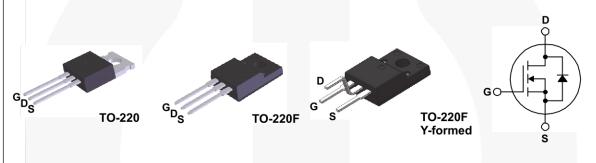
800 V, 8.0 A, 1.55 Ω

Description

This N-Channel enhancement mode power MOSFET is produced using Fairchild Semiconductor's proprietary planar stripe and DMOS technology. This advanced MOSFET technology has been especially tailored to reduce on-state resistance, and to provide superior switching performance • Low Crss (Typ. 13 pF) and high avalanche energy strength. These devices are suitable for switched mode power supplies, active power • 100% Avalanche Tested factor correction (PFC), and electronic lamp ballasts.

Features

- 8.0 A, 800 V, $R_{DS(on)}$ = 1.55 Ω (Max.) @ V_{GS} = 10 V, $I_D = 4.0 A$
- Low Gate Charge (Typ. 35 nC)



Absolute Maximum Ratings T_C = 25°C unless otherwise noted.

Symbol	Parameter		FQP8N80C	FQPF8N80C	Unit
V _{DSS}	Drain-Source Voltage		800		V
I _D	Drain Current - Continuous (T _C = 25°C)		8	8 *	Α
	- Continuous (T _C = 100°C)		5.1	5.1 *	Α
I _{DM}	Drain Current - Pulsed	(Note 1)	32	32 *	Α
V _{GSS}	Gate-Source Voltage		±30		V
E _{AS}	Single Pulsed Avalanche Energy	(Note 2)	850		mJ
I _{AR}	Avalanche Current	(Note 1)	8		Α
E _{AR}	Repetitive Avalanche Energy	(Note 1)	17.8		mJ
dv/dt	Peak Diode Recovery dv/dt	(Note 3)	4.5		V/ns
P_D	Power Dissipation (T _C = 25°C)		178	59	W
- Derate above 25°C			1.43	0.48	W/°C
T_J , T_{STG}	Operating and Storage Temperature Range		-55 to +150		°C
TL	Maximum lead temperature for soldering, 1/8" from case for 5 seconds		3	°C	

* Drain current limited by maximum junction temperature.

Thermal Characteristics

Symbol	Parameter	FQP8N80C	FQPF8N80C	Unit
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case, Max.	0.89	2.66	°C/W
$R_{\theta CS}$	Thermal Resistance, Case-to-Sink Typ, Max.	0.5		°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient, Max.	62.5	62.5	°C/W

Package Marking and Ordering Information

Part Number	Top Mark	Package	Packing Method	Reel Size	Tape Width	Quantity
FQP8N80C	FQP8N80C	TO-220	Tube	N/A	N/A	50 units
FQPF8N80C	FQPF8N80C	TO-220F	Tube	N/A	N/A	50 units
FQPF8N80CYDTU	FQPF8N80C	TO-220F (Y-formed)	Tube	N/A	N/A	50 units

Electrical Characteristics

T_C = 25°C unless otherwise noted.

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
Off Cha	aracteristics					
BV _{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0 \text{ V}, I_{D} = 250 \mu\text{A}$	800			V
ΔBV _{DSS} / ΔT _J	Breakdown Voltage Temperature Coefficient	I _D = 250 μA, Referenced to 25°C		0.5		V/°C
I _{DSS} Zero Gate Vol	Zana Oata Valtana Dusin Ourset	V _{DS} = 800 V, V _{GS} = 0 V			10	μΑ
	Zero Gate Voltage Drain Current	V _{DS} = 640 V, T _C = 125°C			100	μΑ
I _{GSSF}	Gate-Body Leakage Current, Forward	V _{GS} = 30 V, V _{DS} = 0 V			100	nA
I _{GSSR}	Gate-Body Leakage Current, Reverse	V _{GS} = -30 V, V _{DS} = 0 V			-100	nA
On Cha	racteristics					
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	3.0		5.0	V
R _{DS(on)}	Static Drain-Source On-Resistance	V _{GS} = 10 V, I _D = 4 A		1.29	1.55	Ω
g _{FS}	Forward Transconductance	V _{DS} = 50 V, I _D = 4 A (Note 4)		5.6		S
C _{iss}	ic Characteristics Input Capacitance	V _{DS} = 25 V, V _{GS} = 0 V,		1580	2050	pF
C _{oss}	Output Capacitance	f = 1.0 MHz		135	175	pF
C _{rss}	Reverse Transfer Capacitance			13	17	pF
Switchi	ing Characteristics					
t _{d(on)}	Turn-On Delay Time	V _{DD} = 400 V, I _D = 8 A,		40	90	ns
t _r	Turn-On Rise Time	$R_G = 25 \Omega$		110	230	ns
$t_{d(off)}$	Turn-Off Delay Time		,	65	140	ns
t _f	Turn-Off Fall Time	(Note 4, 5)	/	70	150	ns
Q_g	Total Gate Charge	V _{DS} = 640 V, I _D = 8 A, V _{GS} = 10 V		35	45	nC
Q _{gs}	Gate-Source Charge			10		nC
Q_{gd}	Gate-Drain Charge	(Note 4, 5)		14		nC
	Source Diode Characteristics a	nd Maximum Ratings				
I _S	Maximum Continuous Drain-Source Diode Forward Current				8	Α
I _{SM}	Maximum Pulsed Drain-Source Diode F	Forward Current			32	Α

 V_{SD}

 t_{rr}

 Q_{rr}

Notes: 1. Repetitive rating : pulse-width limited by maximum junction temperature. 2. L = 25 mH, I_{AS} = 8 A, V_{DD} = 50 V, R_{G} = 25 Ω , starting T_{J} = 25°C. 3. $I_{SD} \leq$ 8 A, di/dt \leq 200 A/µs, $V_{DD} \leq$ BV $_{DSS}$, starting T_{J} = 25°C. 4. Pulse test : pulse-width \leq 300 µs, duty cycle \leq 2%. 5. Essentially independent of operating temperature.

Drain-Source Diode Forward Voltage

Reverse Recovery Time

Reverse Recovery Charge

1.4

690

8.2

(Note 4)

V

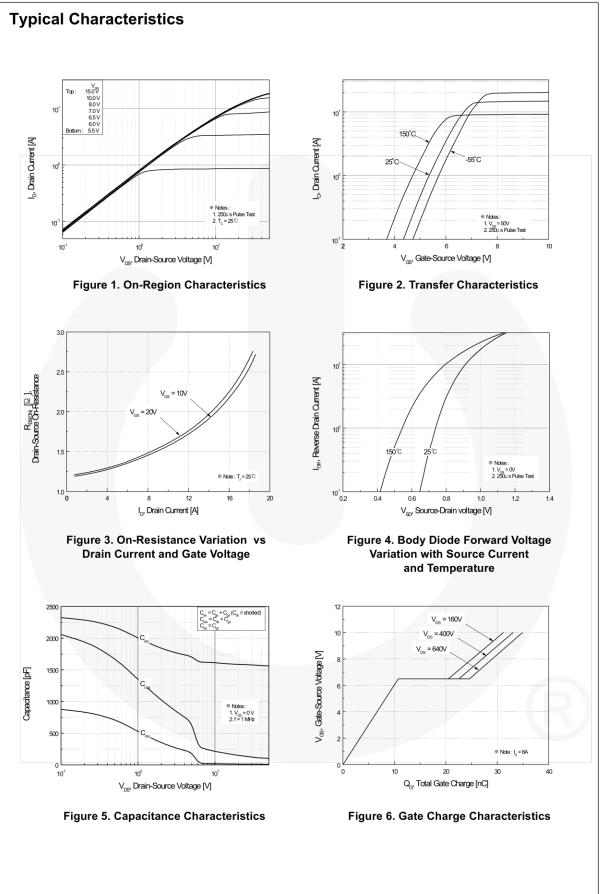
ns

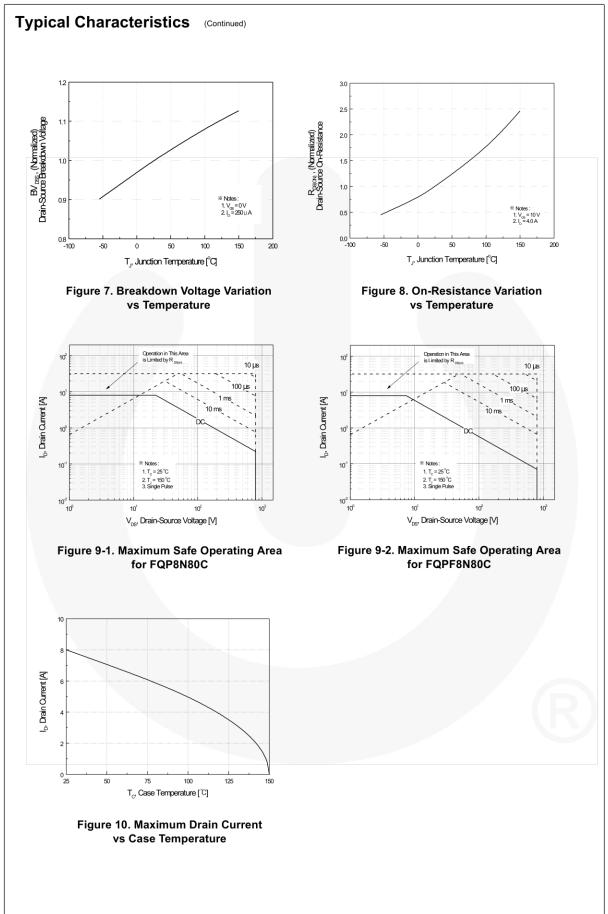
μC

 $V_{GS} = 0 \text{ V, } I_{S} = 8 \text{ A}$

 $V_{GS} = 0 V, I_{S} = 8 A,$

 $dI_{F} / dt = 100 A/\mu s$







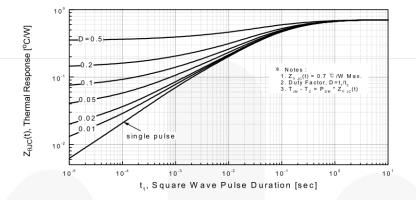


Figure 11-1. Transient Thermal Response Curve for FQP8N80C

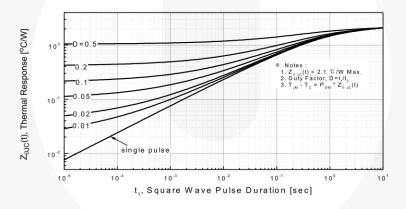
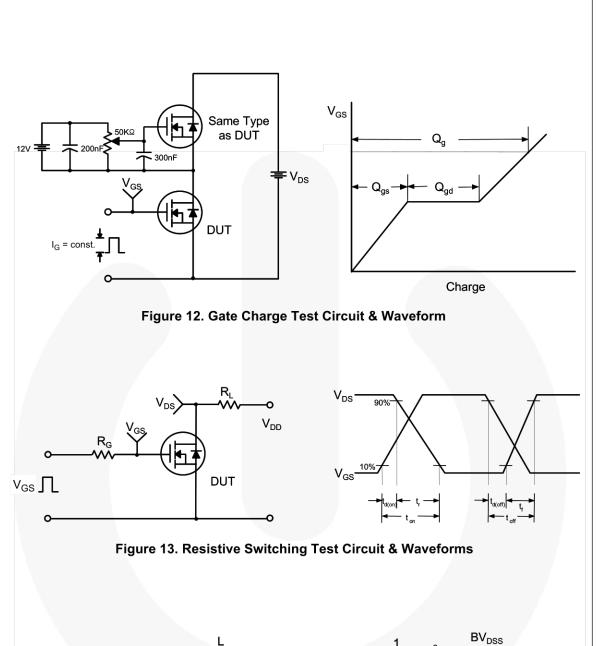


Figure 11-2. Transient Thermal Response Curve for FQPF8N80C



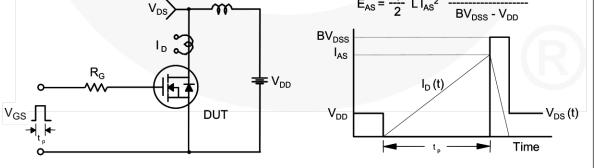
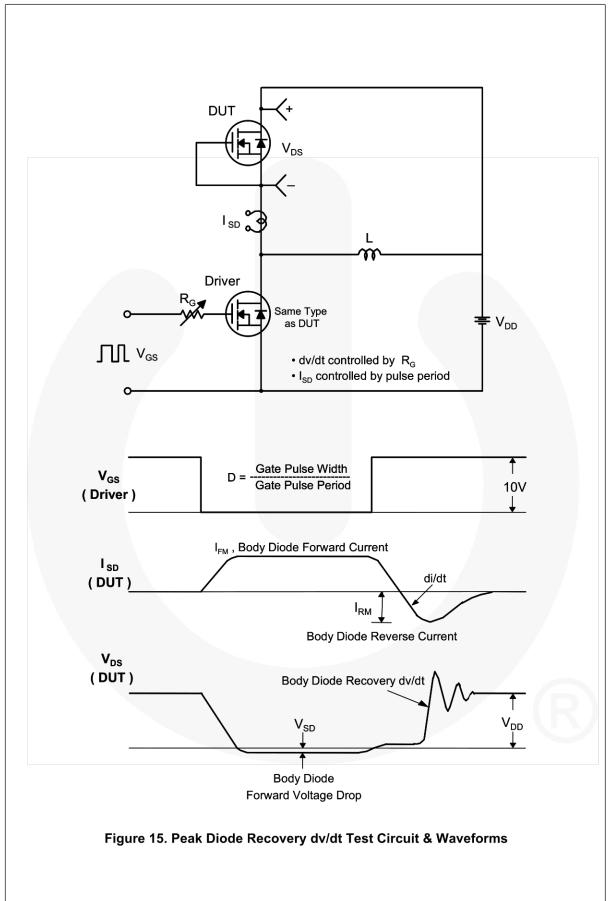


Figure 14. Unclamped Inductive Switching Test Circuit & Waveforms



Mechanical Dimensions

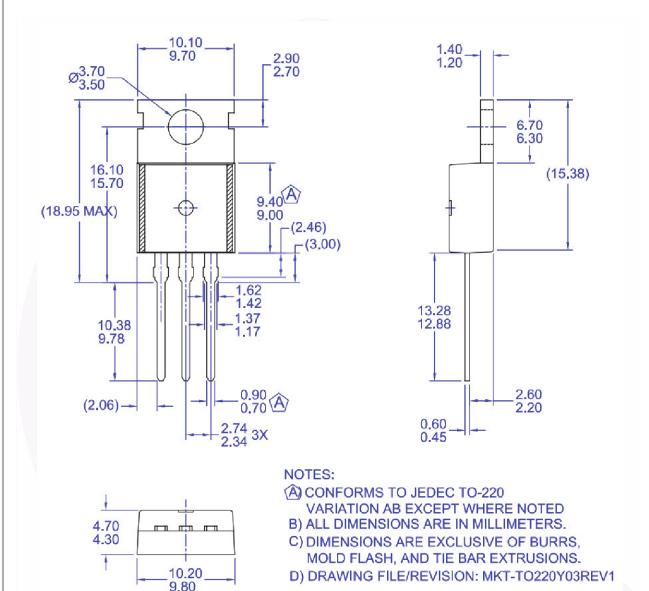


Figure 16. TO220, Molded, 3-Lead, Jedec Variation AB

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Mechanical Dimensions

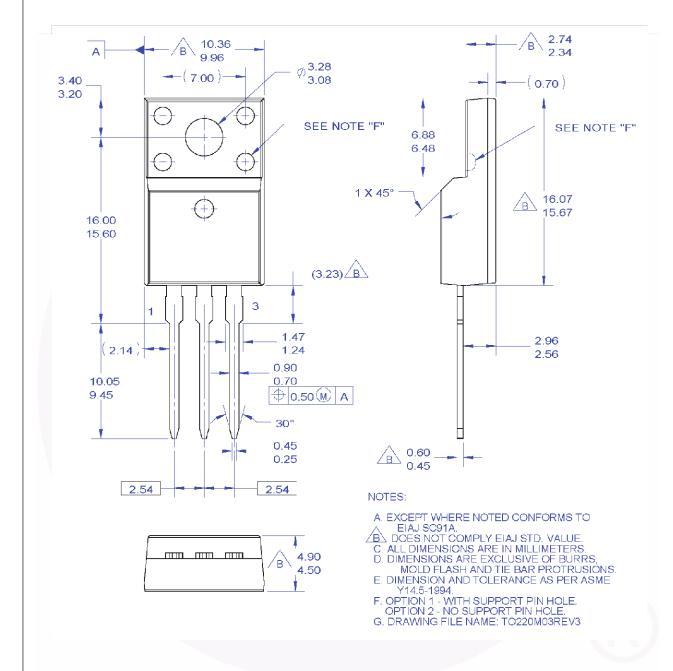


Figure 17. TO220, Molded, 3-Lead, Full Pack, EIAJ SC91, Straight Lead

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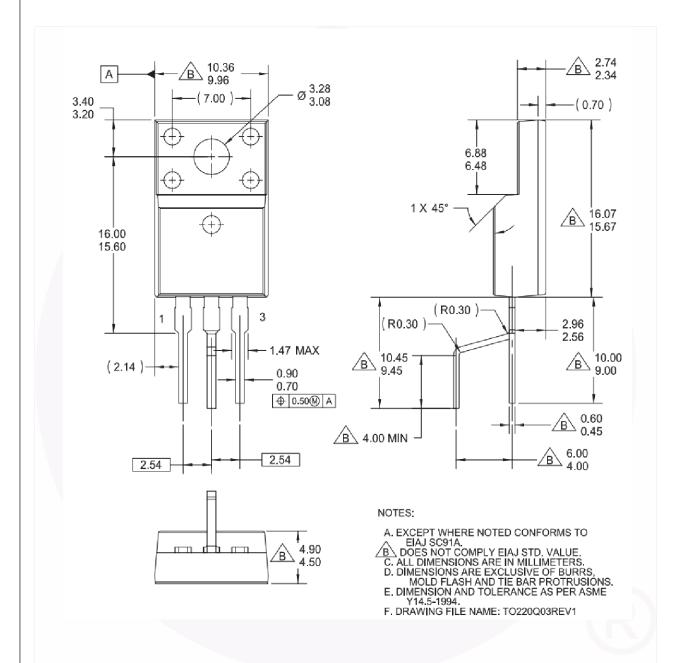


Figure 18. TO220, Molded, 3-Lead, Full Pack, EIAJ SC91, Y-Formed

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